



Product Change Notification

Change Notification #: 114789 - 00
Change Title: Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 0.5m 30 AWG CBL10600H30,
Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 1m 30 AWG CBL10600130,
Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 2m 30 AWG CBL10600230,
Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 3m 28 AWG CBL10600328,
Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 5m 26 AWG CBL10600526,
PCN 114789-00, Order Code, Product Material,
Product Conversion, New Order codes
Date of Publication: August 9, 2016

Key Characteristics of the Change:

Order Code, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 01, 2016
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The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

Affected Product Code	Product Description
CBL10600H30	Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 0.5m 30 AWG CBL10600H30
CBL10600H30	Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 1m 30 AWG CBL10600130
CBL10600230	Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 2m 30 AWG CBL10600230
CBL10600328	Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 3m 28 AWG CBL10600328
CBL10600526	Intel® True Scale Fabric Passive Copper Cable QSFP-QSFP 5m 26 AWG CBL10600526

Overview of Changes:

The Intel® True Scale Fabric Passive Copper Cable SKUs listed in the product affected table below are undergoing part number conversion.

Underlying this change, new MMs are being used to track conversion to cable assemblies for the removal of expiring RoHS II exemption 7(b), in support of RoHS 2016 requirements. Prior to April 2014, these cables had used RoHS 7(b) Exemption for the presence of Lead (Pb) in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission as well as network management for telecommunications. Supplier materials were converted without part number changes in April 2014, which were trackable by serial number date code, but not by orderable part number. New part numbers are now being used to improve traceability of the removed exemption.

Customer Impact of Change and Recommended Action:

There is no change to fit or function; only visible part numbers are changing. The material change described in this PCN to existing MMs is also traceable through serial number date codes. Intel is not recommending additional qualification of these cables by customers.

Please contact your local Intel Field Sales Representative if you have any questions about this change.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion MM#	Post Conversion Product Code	Post Conversion MM#
Intel® True Scale Fabric Passive Copper	CBL10600130	924500	CBL10600130	949740
Intel® True Scale Fabric Passive Copper	CBL10600230	924504	CBL10600230	949741
Intel® True Scale Fabric Passive Copper	CBL10600328	924505	CBL10600328	949742
Intel® True Scale Fabric Passive Copper	CBL10600526	924510	CBL10600526	949743
Intel® True Scale Fabric Passive Copper	CBL10600H30	924511	CBL10600H30	949739

PCN Revision History:

Date of Revision:
August 9, 2016

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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